

REMARKS

Applicants submit herewith an executed Declaration and Power of Attorney.

Applicants have amended the Title to correct a grammatical error in the Title as originally filed.

Applicants submit herewith a replacement Abstract.

Applicants submit herewith a Substitute Specification to replace the specification as originally filed. A red-line illustrating changes made to the PCT specification is also submitted.

Examination of the application is requested.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 07-0153, under Order No. 61919-24USPX.

Dated: May 4, 2007

Respectfully submitted,

By 

Andre M. Szuwalski

Registration No. 35,701

GARDERE WYNNE SEWELL LLP

1601 Elm Street, Suite 3000

Dallas, Texas 75201

(214) 999-4795

Attorneys For Applicant



CUSTOMER NO. 23932

PATENT APPLICATION
Docket #: 61919-24USPX

ABSTRACT OF THE DISCLOSURE

An electronic integrated circuit is fabricated by forming on a substrate, of which a part is composed of absorbing material, a portion made of a sacrificial material. The sacrificial material includes cobalt, nickel, titanium, tantalum, tungsten, molybdenum, gallium, indium, silver, gold, iron and/or chromium. A rigid portion is then formed in fixed contact with the substrate, on one
5 side of the portion of sacrificial material opposite to the part of the substrate composed of absorbing material. The circuit is heated such that the sacrificial material is absorbed into the part of the substrate composed of absorbing material. A substantially empty volume is thus created in place of the portion of sacrificial material. The volume that is substantially empty can replace a dielectric material situated between the electrodes of a capacitor.